# TO OUR VALUED CUSTOMERS

It is our intention to provide our valued customers with the best documentation possible to ensure successful use of your Microchip products. To this end, we will continue to improve our publications to better suit your needs. Our publications will be refined and enhanced as new volumes and updates are introduced.

If you have any questions or comments regarding this publication, please contact the Marketing Communications Department via E-mail at docerrors@microchip.com. We welcome your feedback.

#### Most Current Data Sheet

To obtain the most up-to-date version of this data sheet, please register at our Worldwide Web site at:

#### http://www.microchip.com

You can determine the version of a data sheet by examining its literature number found on the bottom outside corner of any page. The last character of the literature number is the version number, (e.g., DS30000000A is version A of document DS30000000).

#### Errata

An errata sheet, describing minor operational differences from the data sheet and recommended workarounds, may exist for current devices. As device/documentation issues become known to us, we will publish an errata sheet. The errata will specify the revision of silicon and revision of document to which it applies.

To determine if an errata sheet exists for a particular device, please check with one of the following:

- Microchip's Worldwide Web site; <a href="http://www.microchip.com">http://www.microchip.com</a>
- Your local Microchip sales office (see last page)

When contacting a sales office, please specify which device, revision of silicon and data sheet (include -literature number) you are using.

#### **Customer Notification System**

Register on our web site at www.microchip.com to receive the most current information on all of our products.

## **Table of Contents**

1.0 Introduction	4
2.0 Acronyms	
3.0 Pin Configuration	7
3.0 Pin Configuration	8
5.0 Block Diagram	9
5.0 Block Diagram 6.0 Pin Descriptions	. 10
7.0 Configuration Options	. 15
8.0 DC Parameters	. 39
9.0 AC Specifications	. 44
10.0 Package Information	. 45
Appendix A: Data Sheet Revision History	
The Microchip Web Site	. 50
Customer Change Notification Service	. 50
Customer Support	. 50
Product Identification System	. 51

<sup>© 2014-2017</sup> Microchip Technology Inc.

# 1.0 INTRODUCTION

The Microchip Automotive Grade USB 2.0 4-Port Hub is a low-power, OEM configurable, MTT (Multi- Transaction Translator) hub controller IC with 4 downstream ports for embedded USB solutions. It is designed, fabricated, tested, characterized and qualified for automotive applications. The 4-port hub is fully compliant with the USB 2.0 Specification. The USB82514 will attach to an upstream port as a full-speed hub or as a full-/hi-speed hub. The 4-port hub supports lowspeed, full-speed, and hi-speed (if operating as a hi-speed hub) downstream devices on all of the enabled downstream ports.

All required resistors on the USB ports are integrated into the hub. This includes all series termination resistors on D+ and D- pins and all required pull-down and pull-up resistors on D+ and D- pins. The over-current sense inputs for the downstream facing ports have internal pull-up resistors.

The USB82514 includes over 30 programmable features including:

**MultiTRAK™ Technology** which utilizes a dedicated TT per port to maintain consistent full-speed data throughput regardless of the number of active downstream connections. MultiTRAK outperforms conventional USB 2.0 hubs with a single TT in USB full-speed data transfers.

**PortMap** which provides flexible port mapping and disable sequences. The downstream ports of a USB82514 hub can be reordered or disabled in any sequence to support multiple platform designs with minimum effort. For any port that is disabled, the USB82514 automatically reorders the remaining ports to match the USB host controller's port numbering scheme.





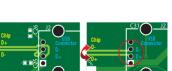
**PortSwap** which adds per-port programmability to USB differential-pair pin locations. PortSwap allows direct alignment of USB signals (D+/D-) to connectors avoiding uneven trace length or crossing of the USB differential signals on the PCB.

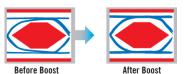
**PHYBoost** which enables four programmable levels of USB signal drive strength in downstream port transceivers. PHYBoost attempts to restore USB signal integrity that has been compromised by system level variables such as poor PCB layout, long cables, etc. The boost graphic shows an example of hi-speed USB eye diagrams before (PHYBoost at 0%) and after (PHYBoost at 12%) signal integrity restoration in a compromised system environment.

The USB82514 is specifically tailored for use in automotive applications requiring

automotive grade robustness starting with the comprehension of proprietary design for reliability techniques within the silicon IC itself as well as for the package design. Automotive qualified technologies and processes are used to fabricate the products with enhanced monitors to continuously drive improvements in accordance with our zero-dpm methodology. Product qualification is focused on customer expectations and exceeds many of the automotive reliability standards including AEC-Q100.

Microchip automotive services are provided during the life of the product from a dedicated organization composed of operations, quality, and product support personnel specialized in meeting the requirements of the automotive customer.





### 1.1 OEM Selectable Features

A default configuration is available in the USB82514 following a reset. This configuration may be sufficient for some applications. Strapping option pins make it possible to modify a limited sub-set of the configuration options.

The USB82514 may also be configured by an external EEPROM or a microcontroller. When using the microcontroller interface, the hub appears as an SMBus slave device. If the hub is pin-strapped for external EEPROM configuration but no external EEPROM is present, then a value of '0' will be written to all configuration data bit fields (the hub will attach to the host with all '0' values).

The USB82514 supports several OEM selectable features:

- Optional OEM configuration via I<sup>2</sup>C EEPROM or via the industry standard SMBus interface from an external SMBus host or microcontroller, see Table 7-1, "Hub Configuration Options" to configure the serial port interface behavior via the CFG\_SEL1 and CFG\_SEL0 pins.
- Compound device support (port is permanently hardwired to a downstream USB peripheral device), on a port-byport basis, see "Register 07h: Configuration Data Byte 2", bit COMPOUND.
- Select Single-Transaction Translator (STT) or Multi-Transaction Translator (MTT), see "Register 06h: Configuration Data Byte 1", bit MTT\_ENABLE.
- Select over-current sensing and port power control on an individual (port-by-port) or ganged (all ports together) basis to match the OEM's choice of circuit board component selection, see "Register 06h: Configuration Data Byte 1", bits CURRENT\_SNS and PORT\_PWR.
- Customize vendor ID, product ID, and device ID, see "Register 00h: Vendor ID (LSB)", "Register 01h: Vendor ID (MSB)", "Register 02h: Product ID (LSB)", "Register 03h: Product ID (MSB)", "Register 04h: Device ID (LSB)" and "Register 05h: Device ID (MSB)".
- Easily configure as a 2, 3 or 4-Port Hub in common PCB layout, see "Register 0Ah: Port Disable for Self-Powered Operation" and "Register 0Bh: Port Disable for Bus-Powered Operation".
- PortMap: Flexible port mapping and disable sequence. Ports can be disabled/reordered in any sequence to support multiple platforms with a single design. The hub will automatically reorder the remaining ports to match the host controller's numbering scheme, see "Register FBh: PortMap 12" and "Register FCh: PortMap 34".
- PortSwap: Programmable USB differential-pair pin location.
- Eases PCB layout by aligning USB signal lines directly to connectors, see "Register FAh: PortSwap".
- PhyBoost: Programmable USB signal drive strength. Recover USB signal integrity due to compromised system environments using 4 levels of signal drive strength, see "Register F6h: Boost\_Up" and "Register F8h: Boost\_4:0".
- Configure the delay time for filtering the over-current sense inputs, see "Register 07h: Configuration Data Byte 2", bit OC\_TIMER.
- · Configure the downstream port power-on time reported to the host, see "Register 10h: Power-On Time".
- Indicate the maximum current that the 4-port hub consumes from the USB upstream port, see "Register 0Eh: Hub Controller Max Current for Self-Powered Operation" and "Register 0Fh: Hub Controller Max Current for Bus-Powered Operation".
- Indicate the maximum current required for the hub controller, see "Register 0Ch: Max Power for Self-Powered Operation" and "Register 0Dh: Max Power for Bus-Powered Operation".
- Support custom string descriptor up to 31 characters in length for:
- Manufacturer string, see "Register 16h-53h: Manufacturer String".
- Product string, see "Register 54h-91h: Product String".
- Serial number string, see "Register 92h-CFh: Serial String".
- Pin selectable options for default configuration:
  - Downstream ports as non-removable ports, see "Register 09h: Non-Removable Device".
  - Downstream ports as disabled ports, see "Register 0Ah: Port Disable for Self-Powered Operation" and "Register 0Bh: Port Disable for Bus-Powered Operation".

# 2.0 ACRONYMS

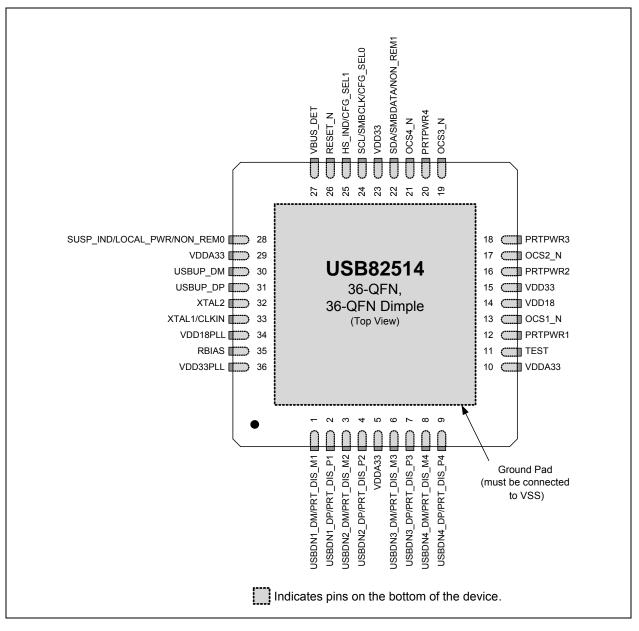
The following is a list of the general terms used throughout this document:

## TABLE 2-1: ACRONYMS

Acronym	Description			
ACK	andshake packet indicating a positive acknowledgment			
EOF	End of (micro) Frame			
EOP	End of Packet			
l <sup>2</sup> C	Inter-Integrated Circuit			
MTT	Multi-Transaction Translator			
OCS	Over-current Sense			
PCB	Printed Circuit Board			
PHY	Physical Layer			
PLL	Phase-Locked Loop			
QFN	Quad Flat No Leads			
RoHS	Restriction of Hazardous Substances directive			
SMBus	System Management Bus			
STT	Single-Transaction Translator			
TT	Transaction Translator			

## 3.0 PIN CONFIGURATION





<sup>© 2014-2017</sup> Microchip Technology Inc.

# USB82514

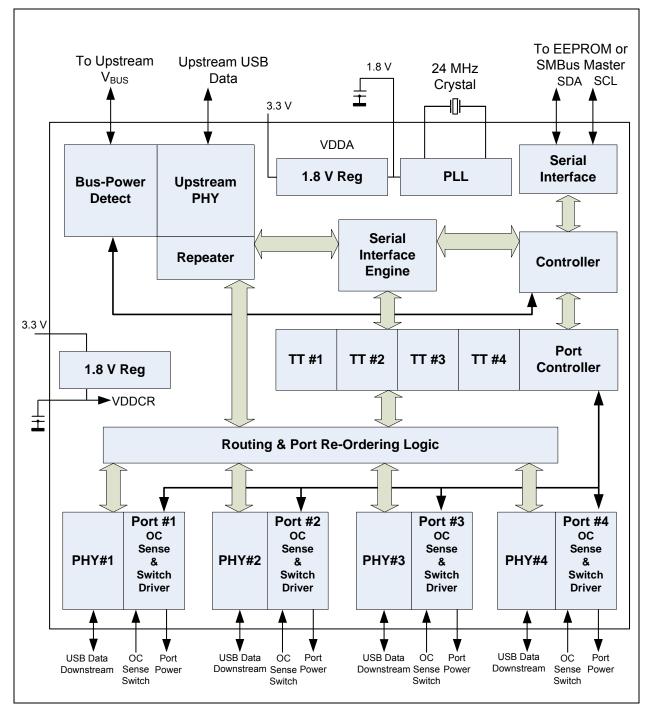
## 4.0 PIN TABLE

## TABLE 4-1: USB82514 36-PIN TABLE

Upstream USB Interfaces (3 Pins)						
USBUP_DP	USBUP_DM	VBUS_DET				
	Downstream USB 2.0	0 Interfaces (17 Pins)				
USBDN1_DP/ PRT_DIS_P1	USBDN2_DP/ PRT_DIS_P2	USBDN4_DP/ PRT_DIS_P4				
USBDN1_DM/ PRT_DIS_M1	USBDN2_DM/ PRT_DIS_M2	USBDN3_DM/ PRT_DIS_M3	USBDN4_DM/ PRT_DIS_M4			
PRTPWR1	PRTPWR2	PRTPWR3	PRTPWR4			
OCS1_N	OCS2_N	OCS3_N	OCS4_N			
RBIAS						
	Serial Port Inte	erfaces (3 Pins)				
SDA/ SMBDATA/ NON_REM1	SCL/ SMBCLK/ CFG_SEL0	HS_IND/ CFG_SEL1				
	Misc (	5 Pins)				
XTAL1/CLKIN	XTAL2	RESET_N	SUSP_IND/ LOCAL_PWR/ NON_REM0			
TEST						
	Analog / Digital Power (8 Pins)					
(2) VDD33	(3) VDDA33	VDD18PLL				
VDD33PLL						
Total 36 Pins						

## 5.0 BLOCK DIAGRAM





<sup>© 2014-2017</sup> Microchip Technology Inc.

## 6.0 PIN DESCRIPTIONS

This section provides a detailed description of each signal. The signals are arranged in functional groups according to their associated interface.

The "N" symbol in the signal name indicates that the active, or asserted, state occurs when the signal is at a low voltage level. When "N" is not present after the signal name, the signal is asserted when at the high voltage level.

The terms assertion and negation are used exclusively. This is done to avoid confusion when working with a mixture of "active low" and "active high" signals. The term assert, or assertion, indicates that a signal is active, independent of whether that level is represented by a high or low voltage. The term negate, or negation, indicates that a signal is inactive.

Symbol	36 QFN	Buffer Type	Description
		UP	STREAM USB INTERFACES
USBUP_DP USBUP_DM	31 30	IO-U	USB Bus Data These pins connect to the upstream USB bus data signals (host port or upstream hub).
VBUS_DET	27	I	Detect Upstream VBUS Power Detects state of upstream VBUS power. The Microchip hub monitors VBUS_DET to determine when to assert the internal D+ pull-up resis- tor (signaling a connect event). When designing a detachable hub, this pin must be connected to the VBUS on the upstream port via a 2 to 1 voltage divider. For self-powered applications with a permanently attached host, this pin must be connected to 3.3 V (typically VDD33).
		DOW	NSTREAM USB 2.0 INTERFACE
USBDN[4:1]_DP/ PRT_DIS_P[4:1] &	9 7 4 2	IO-U	Hi-Speed USB Data These pins connect to the downstream USB peripheral devices attached to the hub's port.
USBDN[4:1]_DM/ PRT_DIS_M[4:1]	8 6 3 1		Downstream Port Disable Strap Option If this strap is enabled by package and configuration settings (see Table 7-1, "Hub Configuration Options"), this pin will be sampled at RESET_N negation to determine if the port is disabled. Both USB data pins for the corresponding port must be tied to the VDDA33 to disable the associated downstream port.
PRTPWR[4:1]	20 18 16 12	O12	USB Port Power Enable Enables power to downstream USB peripheral devices. <b>Note:</b> The hub will only support active high power controllers.

TABLE 6-1: USB82514 PIN DESCRIPTIONS

TINUED)

Symbol	36 QFN	Buffer Type	Description
OCS_N[4:1]	21 19 17 13	IPU	Over-current Sense Input from external current monitor indicating an over-current condition.
RBIAS	35	I-R	USB Transceiver Bias A 12.0 k $\Omega$ (+/- 1%) resistor is attached from ground to this pin to set the transceiver's internal bias settings.
		9	SERIAL PORT INTERFACE
SDA/	22	I/OSD12	Serial Data
SMBDATA/			SMB Data
NON_REM1			NON_REM1: Non-removable port strap option.
			If this strap is enabled by package and configuration settings (see Table 7-1, "Hub Configuration Options"), this pin will be sampled (in conjunction with SUSP_IND/LOCAL_PWR/NON_REM0) at RESET_N negation to determine if ports [4:1] contain permanently attached (non-removable) devices:
			NON_REM[1:0] = '00', All ports are removable,
			NON_REM[1:0] = '01', Port 1 is non-removable,
			NON_REM[1:0] = '10', Ports 1 & 2 are non-removable,
			NON_REM[1:0] = '11', Ports 1, 2 & 3 are non-removable.
SCL/	24	I/OSD12	Serial Clock (SCL)
SMBCLK/			SMBus Clock (SMBCLK)
CFG_SEL0			Configuration Select_SEL0: The logic state of this multifunction pin is internally latched on the rising edge of RESET_N (RESET_N negation) and will determine the hub configuration method as described in Table 7-1, "Hub Configuration Options".

## TABLE 6-1: USB82514 PIN DESCRIPTIONS (CONTINUED)

Symbol	36 QFN	Buffer Type	Description
HS_IND/	25	I/O12	Hi-Speed Upstream Port Indicator Configuration Programming Select
			HS_IND: Hi-Speed Indicator for upstream port connection speed.
			The active state of HS_IND will be determined as follows:
CFG_SEL1			CFG_SEL1 = '0', Configuration Programming Select
			HS_IND is active high,
			CFG_SEL1 = '1', HS_IND is active low,
			'Asserted' = Hub is connected at HS 'Negated' = Hub is connected at FS
			<b>Note:</b> An LED can be attached to this signal for visual indication.
			CFG_SEL1: The logic state of this pin is internally latched on the rising edge of RESET_N (RESET_N negation), and will determine the hub configuration method as described in Table 7-1, "Hub Configuration Options".
			MISC
XTAL1/ CLKIN	33	ICLKx	Crystal Input/External Clock Input
CLNIN			This pin connects to either one terminal of the crystal or to an external 24 MHz clock when a crystal is not used. When used with an external clock, the signal level must comply with the ICLK buffer levels.
XTAL2	32	OCLKx	Crystal Output
			24 MHz Crystal
			This is the other terminal of the crystal, or it is left disconnected when an external clock source is used to drive XTAL1/CLKIN.
			<b>Note:</b> This output must not be used to drive any external circuitry other than the crystal circuit.
RESET_N	26	IS	RESET Input
			The system can reset the chip by driving this input low. The minimum active low pulse is 1 $\mu s$ after all power supply voltages are at nominal levels.

Symbol	36 QFN	Buffer Type	Description
SUSP_IND/	28	I/O12	Active/Suspend Status Signal Indicator or Local-Power & Non-Remov- able Strap Option
LOCAL_PWR/			Suspend Indicator: Indicates USB state of the hub. 'negated' = Unconfigured, or configured and in USB suspend
NON_REM0			'asserted' = Hub is configured, and is active (i.e., not in suspend)
			<b>Note:</b> An LED can be attached to this signal for visual indication.
			Local Power: Detects availability of local self-power source
			Low = Self/local power source is NOT available (i.e., hub gets all power from Upstream USB VBus).
			High = Self/local power source is available.
			NON_REM0 Strap Option:
			If this strap is enabled by package and configuration settings (see Table 7-1, "Hub Configuration Options"), this pin will be sampled (in conjunction with NON_REM1) at RESET_N negation to determine if ports [4:1] contain permanently attached (non-removable) devices. Also, the active state of the signal will be determined as follows:
			NON_REM[1:0] = '00', All ports are removable, and the SUSP_IND sig- nal is active high,
			NON_REM[1:0] = '01', Port 1 is non-removable, and the SUSP_IND signal is active low,
			NON_REM[1:0] = '10', Ports 1 & 2 are non-removable, and the SUS- P_IND signal is active high,
			NON_REM[1:0] = '11', Ports 1, 2 & 3 are non-removable, and the SUS- P_IND signal is active low.
TEST	11	IPD	TEST pin
			Tie this pin to ground for normal operation.
			POWER / GROUND
VDD18	14		VDD Core
			+1.8 V core power. This pin must have a 1.0 $\mu F$ (or greater) ±20% (ESR <0.1 $\Omega$ ) capacitor to VSS.
VDD33PLL	36		VDD 3.3 PLL Regulator Reference
			+3.3 V power supply for the PLL.

<sup>© 2014-2017</sup> Microchip Technology Inc.

## TABLE 6-1: USB82514 PIN DESCRIPTIONS (CONTINUED)

Symbol	36 QFN	Buffer Type	Description
VDD18PLL	34		VDD PLL +1.8 V Filtered analog power for internal PLL. This pin must have a 1.0 $\mu$ F (or greater) ±20% (ESR <0.1 $\Omega$ ) capacitor to VSS.
VDDA33	5 10 29		VDD Analog I/O         +3.3 V Filtered analog PHY power, shared between adjacent ports.
VDD33	23 15		VDDIO/VDD 3.3 Core Regulator Reference +3.3 V power supply for the digital I/O. VDD33 acts as the regulator input.
VSS			VSS Ground (The thermal slug must be connected to VSS.)

## TABLE 6-2: USB82514 BUFFER TYPE DESCRIPTIONS

Buffer	Description		
I	Input		
IPD	Input with internal weak pull-down resistor		
IPU	Input with internal weak pull-up resistor		
IS	Input with Schmitt trigger		
O12	Output 12 mA		
I/O12	Input/Output buffer with 12 mA sink and 12 mA source		
I/OSD12	Open drain with Schmitt trigger 12 mA sink. Meets $I^2\mbox{C-Bus}$ specification version 2.1 requirements		
ICLKx	XTAL clock input		
OCLKx	XTAL clock output		
I-R	RBIAS		
IO-U	Analog input/output as defined in USB specification		

# 7.0 CONFIGURATION OPTIONS

## 7.1 4-Port Hub

Microchip's Automotive Grade USB 2.0 4-Port Hub is fully compliant to the Universal Serial Bus Specification available from the USB Implementer's Forum found at <a href="http://www.usb.org/developers/docs/">http://www.usb.org/developers/docs/</a> (Revision 2.0 from April 27, 2000 and the 12/7/2000 and 5/28/2002 Errata). Please refer to Chapter 11 (Hub Specification) for general details regarding hub operation and functionality.

For performance reasons, the 4-Port Hub provides 1 Transaction Translator (TT) per port (defined as Multi-TT configuration), and each TT has 1512 bytes of periodic buffer space and 272 bytes of non- periodic buffer space (divided into 4 non-periodic buffers per TT), for a total of 1784 bytes of buffer space for each Transaction Translator.

#### 7.1.1 HUB CONFIGURATION OPTIONS

The Microchip hub supports a large number of features (some are mutually exclusive), and must be configured in order to correctly function when attached to a USB host controller. There are three principal ways to configure the hub: SMBus, EEPROM, or by internal default settings (with or without pin strapping option overrides). In all cases, the configuration method will be determined by the CFG\_SEL1 and CFG\_SEL0 pins immediately after RESET\_N negation.

If the SMBus or EEPROM is selected using the CFG\_SEL pins, then the data read in from the EEPROM/SMBus will take precedence over the pin strapping options. If the internal default setting is selected, the options come from the internal ROM. These values can be selectively overridden using the pin strapping options.

#### 7.1.2 SMBus OR EEPROM INTERFACE

CFG_SEL1	CFG_SEL0	SMBUS OR EEPROM INTERFACE BEHAVIOR
0	0	<ul><li>Internal default configuration</li><li>Strap options enabled</li><li>Self-powered operation enabled</li></ul>
0	1	<ul> <li>Configured as an SMBus slave for external download of user- defined descriptors.</li> <li>SMBus slave address 58 (0101100x)</li> <li>Strap options disabled</li> <li>All settings controlled by registers</li> </ul>
1	0	<ul><li>Internal default configuration</li><li>Strap options enabled</li><li>Bus power operation</li></ul>
1	1	<ul> <li>2-Wire I<sup>2</sup>C EEPROMS are supported</li> <li>Strap options disabled</li> <li>All settings controlled by registers</li> </ul>

#### TABLE 7-1:HUB CONFIGURATION OPTIONS

## 7.1.2.1 Power Switching Polarity

The hub will only support active high power controllers.

#### 7.1.3 VBus DETECT

According to section 7.2.1 of the USB 2.0 Specification, a downstream port can never provide power to its D+ or D- pull up resistors unless the upstream port's VBUS is in the asserted (powered) state. The VBUS\_DET pin on the hub monitors the state of the upstream VBUS signal and will not pull up the D+ resistor if VBUS is not active. If VBUS goes from an active to an inactive state (not powered), the hub will remove power from the D+ pull-up resistor within 10 seconds.

<sup>© 2014-2017</sup> Microchip Technology Inc.

## 7.2 EEPROM Interface

The Microchip hub can be configured via a 2-wire ( $I^2C$ ) EEPROM (256x8). (Please see Table 7-1, "Hub Configuration Options" for specific details on how to enable configuration via an  $I^2C$  EEPROM).

When configured for EEPROM support, the internal state machine will read the external EEPROM for configuration data. The hub will then "attach" to the upstream USB host.

**Note:** The hub does not have the capacity to write, or "Program," an external EEPROM. The hub only has the capability to read external EEPROMs. The external EEPROM will be read (even if it is blank or non-populated), and the hub will be "configured" with the values that are read.

Each register has R/W capability. SMBUS and EEPROM Reset Values are 0x00. Reserved registers should be written to '0' unless otherwise specified.

Reg Addr	Register Name	Internal Default ROM
00h	Vendor ID (LSB)	24h
01h	Vendor ID (MSB)	04h
02h	Product ID (LSB)	14h
03h	Product ID (MSB)	25h
04h	Device ID (LSB)	A0h
05h	Device ID (MSB)	80h
06h	Configuration Data Byte 1	9Bh
07h	Configuration Data Byte 2	20h
08h	Configuration Data Byte 3	02h
09h	Non-Removable Device	00h
0Ah	Port Disable for Self-Powered Operation	00h
0Bh	Port Disable for Bus-Powered Operation	00h
0Ch	Max Power for Self-Powered Operation	01h
0Dh	Max Power for Bus-Powered Operation	32h
0Eh	Hub Controller Max Current for Self-Powered Operation	01h
0Fh	Hub Controller Max Current for Bus-Powered Operation	32h
10h	Power-on Time	32h
11h	Language ID High	00h
12h	Language ID Low	00h
13h	Manufacturer String Length	00h
14h	Product String Length	00h
15h	Serial String Length	00h
16h-53h	Manufacturer String	00h
54h-91h	Product String	00h

#### 7.2.1 INTERNAL REGISTER SET (COMMON TO EEPROM AND SMBus)

DS60001234C-page 16

Reg Addr	Register Name	Internal Default ROM
92h-Cfh	Serial String	00h
D0h-F5h	Reserved	00h
F6h	Boost_Up	00h
F7h	Reserved	00h
F8h	Boost_4:0	00h
F9h	Reserved	00h
FAh	PortSwap 00h	
FBh	PortMap 12	00h
FCh	PortMap 34	00h
FDh	Reserved	00h
FFh	Status/Command	00h
	Note: SMBus register only	

## 7.2.1.1 Register 00h: Vendor ID (LSB)

Bit Number	Bit Name	Description
7:0	VID_LSB	Least Significant Byte of the Vendor ID: This is a 16-bit value that uniquely identifies the Vendor of the user device (assigned by USB-Interface Forum). This field is set by the OEM using either the SMBus or EEPROM interface options.

## 7.2.1.2 Register 01h: Vendor ID (MSB)

Bit Number	Bit Name	Description
7:0	VID_MSB	Most Significant Byte of the Vendor ID: This is a 16-bit value that uniquely iden- tifies the Vendor of the user device (assigned by USB-Interface Forum). This field is set by the OEM using either the SMBus or EEPROM interface options.

## 7.2.1.3 Register 02h: Product ID (LSB)

Bit Number	Bit Name	Description
7:0	PID_LSB	Least Significant Byte of the Product ID: This is a 16-bit value that the Vendor can assign that uniquely identifies this particular product (assigned by OEM). This field is set by the OEM using either the SMBus or EEPROM interface options.

<sup>© 2014-2017</sup> Microchip Technology Inc.

# USB82514

## 7.2.1.4 Register 03h: Product ID (MSB)

Bit Number	Bit Name	Description
7:0	PID_MSB	Most Significant Byte of the Product ID: This is a 16-bit value that the Vendor can assign that uniquely identifies this particular product (assigned by OEM). This field is set by the OEM using either the SMBus or EEPROM interface options.

## 7.2.1.5 Register 04h: Device ID (LSB)

Bit Number	Bit Name	Description
7:0	DID_LSB	Least Significant Byte of the Device ID: This is a 16-bit device release number in BCD format (assigned by OEM). This field is set by the OEM using either the SMBus or EEPROM interface options.

## 7.2.1.6 Register 05h: Device ID (MSB)

Bit Number	Bit Name	Description
7:0	DID_MSB	Most Significant Byte of the Device ID: This is a 16-bit device release number in BCD format (assigned by OEM). This field is set by the OEM using either the SMBus or EEPROM interface options.

# 7.2.1.7 Register 06h: Configuration Data Byte 1

Bit Number	Bit Name	Description
7	SELF_BUS_PWR	Self or Bus-Power: Selects between self and bus-powered operation.
		The hub is either self-powered (draws less than 2 mA of upstream bus power) or bus-powered (limited to a 100 mA maximum of upstream power prior to being configured by the host controller).
		When configured as a bus-powered device, the Microchip hub consumes less than 100 mA of current prior to being configured. After configuration, the bus- powered Microchip hub (along with all associated hub circuitry, any embedded devices if part of a compound device, and 100 mA per externally available downstream port) must consume no more than 500 mA of upstream VBUS current. The current consumption is system dependent, and the OEM must ensure that the USB 2.0 specifications are not violated.
		When configured as a self-powered device, <1 mA of upstream VBUS current is consumed and all ports are available, with each port being capable of sourc- ing 500 mA of current.
		This field is set by the OEM using either the SMBus or EEPROM interface options.
		See description of the DYNAMIC bit (reg 07h, bit 7) for the self-/bus-power functionality when dynamic power switching is enabled.
		<ul><li>'0' = Bus-powered operation</li><li>'1' = Self-powered operation</li></ul>
		<b>Note:</b> If dynamic power switching is enabled, this bit is ignored and the LOCAL_PWR pin is used to determine if the hub is operating from self or bus power.
6	Reserved	Reserved
5	HS_DISABLE	Hi-Speed Disable: Disables the capability to attach as either a Hi-/Full-speed device, and forces attachment as Full-speed only (i.e., no Hi-Speed support).
		'0' = Hi-/Full-Speed '1' = Full-Speed-Only (Hi-Speed is disabled!)
4	MTT_ENABLE	Multi-TT enable: Enables one Transaction Translator per port operation.
		Selects between a mode where only one Transaction Translator is available for all ports (Single-TT), or each port gets a dedicated Transaction Translator (Multi-TT) {Note: The host may force Single-TT mode only}.
		<ul><li>'0' = Single TT for all ports</li><li>'1' = One TT per port (multiple TT's supported)</li></ul>

<sup>© 2014-2017</sup> Microchip Technology Inc.

# USB82514

Bit Number	Bit Name	Description
3	EOP_DISABLE	EOP Disable: Disables EOP generation of EOF1 when in Full-Speed mode. During FS operation only, this permits the hub to send EOP if no downstream traffic is detected at EOF1. See Section 11.3.1 of the USB 2.0 Specification for additional details. Note: generation of an EOP at the EOF1 point may prevent a host controller (operating in FS mode) from placing the USB bus in suspend. '0' = EOP generation is normal '1' = EOP generation is disabled
2:1	CURRENT_SNS	Over-current Sense: Selects current sensing on a port-by-port basis, all ports ganged, or none (only for bus-powered hubs). The ability to support current sensing on a port or ganged basis is hardware implementation dependent. '00' = Ganged sensing (all ports together) '01' = Individual port-by-port '1x' = Over-current sensing not supported (must only be used with bus-pow- ered configurations!)
0	PORT_PWR	Port Power Switching: Enables power switching on all ports simultaneously (ganged), or port power is individually switched on and off on a port-by-port basis (individual). The ability to support power enabling on a port or ganged basis is hardware implementation dependent. '0' = Ganged switching (all ports together) '1' = Individual port-by-port switching

## 7.2.1.8 Register 07h: Configuration Data Byte 2

Bit Number	Bit Name	Description
7	DYNAMIC	Dynamic Power Switching Enable: Controls the ability of the hub to automati- cally change from self-powered operation to bus-powered operation if the local power source is removed or is unavailable (and from bus-powered to self-pow- ered if the local power source is restored). {Note: If the local power source is available, the hub will always switch to self-powered operation.} When dynamic power switching is enabled, the hub detects the availability of a local power source by monitoring the external LOCAL_PWR pin. If the hub detects a change in power source availability, the hub immediately discon- nects and removes power from all downstream devices and disconnects the upstream port. The hub will then re-attach to the upstream port as either a bus- powered hub (if local-power is unavailable) or a self-powered hub (if local power is available). '0' = No dynamic auto-switching '1' = Dynamic auto-switching capable
6	Reserved	Reserved

Bit Number	Bit Name	Description
5:4	OC_TIMER	Over-Current Timer: Over-current timer delay '00' = 0.1  ms '01' = 4.0  ms '10' = 8.0  ms '10' = 8.0  ms
3	COMPOUND	<ul> <li>'11' = 16.0 ms</li> <li>Compound Device: Allows the OEM to indicate that the hub is part of a compound device (see the USB Specification for definition). The applicable port(s) must also be defined as having a "non-removable device".</li> </ul>
		<b>Note:</b> When configured via strapping options, declaring a port as non-removable automatically causes the hub controller to report that it is part of a compound device.
		'0' = No '1' = Yes, the hub is part of a compound device
2:0	Reserved	Reserved

# 7.2.1.9 Register 08h: Configuration Data Byte 3

Bit Number	Bit Name	Description
7:4	Reserved	Reserved
3	PRTMAP_EN	Port Re-mapping Enable: Selects the method used by the hub to assign port numbers and disable ports. '0' = Standard mode '1' = Port re-map mode
2:1	Reserved	Reserved
0	STRING_EN	Enables string descriptor support '0' = String support disabled '1' = String support enabled

<sup>© 2014-2017</sup> Microchip Technology Inc.

# USB82514

#### 7.2.1.10 Register 09h: Non-Removable Device

Bit Number	Bit Name	Description
7:0	NR_DEVICE	Non-Removable Device: Indicates which port(s) include non-removable devices.
		<ul><li>'0' = port is removable</li><li>'1' = port is non-removable</li></ul>
		Informs the host if one of the active ports has a permanent device that is unde- tachable from the hub. (Note: The device must provide its own descriptor data.)
		When using the internal default option, the NON_REM[1:0] pins will designate the appropriate ports as being non-removable.
		Bit 7 = Reserved Bit 6 = Reserved Bit 5 = Reserved Bit 4 = Controls physical port 4 Bit 3 = Controls physical port 3 Bit 2 = Controls physical port 2 Bit 1 = Controls physical port 1 Bit 0 = Reserved

## 7.2.1.11 Register 0Ah: Port Disable for Self-Powered Operation

Bit Number	Bit Name	Description
7:0	PORT_DIS_SP	Port Disable Self-Powered: Disables 1 or more contiguous ports.
		<ul><li>'0' = port is available</li><li>'1' = port is disabled</li></ul>
		During self-powered operation when remapping mode is disabled (PRT-MAP_EN = '0'), this selects the ports which will be permanently disabled, and are not available to be enabled or enumerated by a host controller. The ports can be disabled in any order, the internal logic will automatically report the correct number of enabled ports to the USB host, and will reorder the active ports in order to ensure proper function.
		Bit 7 = Reserved Bit 6 = Reserved Bit 5 = Reserved
		Bit 4 = Controls physical port 4 Bit 3 = Controls physical port 3 Bit 2 = Controls physical port 2
		Bit 1 = Controls physical port 1 Bit 0 = Reserved

Bit Number	Bit Name	Description
7:0	PORT_DIS_BP	Port Disable Bus-Powered: Disables 1 or more contiguous ports. '0' = port is available '1' = port is disabled During self-Powered operation when remapping mode is disabled (PRT- MAP_EN = '0'), this selects the ports which will be permanently disabled, and are not available to be enabled or enumerated by a host controller. The ports can be disabled in any order, the internal logic will automatically report the cor- rect number of enabled ports to the USB host, and will reorder the active ports in order to ensure proper function. When using the internal default option, the PRT_DIS_P[4:1] and PRT_DIS_M[4:1] pins will disable the appropriate ports. Bit 7 = Reserved Bit 6 = Reserved Bit 5 = Reserved Bit 4 = Controls physical port 4 Bit 3 = Controls physical port 2 Bit 1 = Controls physical port 1 Bit 0 = Reserved

## 7.2.1.12 Register 0Bh: Port Disable for Bus-Powered Operation

#### 7.2.1.13 Register 0Ch: Max Power for Self-Powered Operation

Bit Number	Bit Name		Description
7:0	MAX_PWR_SP	from an up value inclu (from VBU the power	r Self_Powered: Value in 2 mA increments that the hub consumes stream port (VBUS) when operating as a self-powered hub. This des the hub silicon along with the combined power consumption S) of all associated circuitry on the board. This value also includes consumption of a permanently attached peripheral if the hub is con- a compound device, and the embedded peripheral reports 0 mA in ors.
		Note:	The USB 2.0 Specification does not permit this value to exceed 100 mA.

#### 7.2.1.14 Register 0Dh: Max Power for Bus-Powered Operation

Bit Number	Bit Name	Description
7:0	MAX_PWR_BP	Max Power Bus_Powered: Value in 2 mA increments that the hub consumes from an upstream port (VBUS) when operating as a bus-powered hub. This value includes the hub silicon along with the combined power consumption (from VBUS) of all associated circuitry on the board. This value also includes the power consumption of a permanently attached peripheral if the hub is con- figured as a compound device, and the embedded peripheral reports 0 mA in its descriptors. A value of 50 (decimal) indicates 100 mA, which is the default value.

### 7.2.1.15 Register 0Eh: Hub Controller Max Current for Self-Powered Operation

Bit Number	Bit Name	Description
7:0	HC_MAX_C_SP	Hub Controller Max Current Self-Powered: Value in 2 mA increments that the hub consumes from an upstream port (VBUS) when operating as a self-pow- ered hub. This value includes the hub silicon along with the combined power consumption (from VBUS) of all associated circuitry on the board. This value does NOT include the power consumption of a permanently attached peripheral if the hub is configured as a compound device.
		Note: The USB 2.0 Specification does not permit this value to exceed 100 mA.

#### 7.2.1.16 Register 0Fh: Hub Controller Max Current for Bus-Powered Operation

Bit Number	Bit Name	Description
7:0	HC_MAX_C_BP	Hub Controller Max Current Bus-Powered: Value in 2 mA increments that the hub consumes from an upstream port (VBUS) when operating as a bus-pow- ered hub. This value will include the hub silicon along with the combined power consumption (from VBUS) of all associated circuitry on the board. This value will NOT include the power consumption of a permanently attached peripheral if the hub is configured as a compound device. A value of 50 (decimal) would indicate 100 mA, which is the default value.

## 7.2.1.17 Register 10h: Power-On Time

Bit Number	Bit Name	Description
7:0	POWER_ON_TIME	Power-On Time: The length of time that it takes (in 2 ms intervals) from the time the host initiated power-on sequence begins on a port until power is stable on that port.

#### 7.2.1.18 Register 11h: Language ID High

Bit Number	Bit Name	Description
7:0	LANG_ID_H	USB LANGUAGE ID (Upper 8 bits of a 16-bit ID field)

#### 7.2.1.19 Register 12h: Language ID Low

Bit Number	Bit Name	Description
7:0	LANG_ID_L	USB LANGUAGE ID (Lower 8 bits of a 16-bit ID field)

## 7.2.1.20 Register 13h: Manufacturer String Length

Bit Number	Bit Name	Description           Manufacturer String Length           Maximum string length is 31 characters.	
7:0	MFR_STR_LEN		

## 7.2.1.21 Register 14h: Product String Length

Bit Number	Bit Name	Description
7:0	PRD_STR_LEN	Product String Length
		Maximum string length is 31 characters.

### 7.2.1.22 Register 15h: Serial String Length

Bit Number	Bit Name	Description
7:0	SER_STR_LEN	Serial String Length
		Maximum string length is 31 characters.

<sup>© 2014-2017</sup> Microchip Technology Inc.

## 7.2.1.23 Register 16h-53h: Manufacturer String

Bit Number	Bit Name	Description
7:0	MFR_STR	Manufacturer String, UNICODE UTF-16LE per USB 2.0 Specification Maximum string length is 31 characters (62 bytes).
		<b>Note:</b> The string consists of individual 16-bit UNICODE UTF-16LE characters. The characters will be stored starting with the LSB at the least significant address and the MSB at the next 8-bit location (subsequent characters must be stored in sequential contiguous address in the same LSB, MSB manner). Some EEPROM programmers may transpose the MSB and LSB, thus reversing the byte order. Please pay careful attention to the byte ordering for your selected programming tools.

## 7.2.1.24 Register 54h-91h: Product String

Bit Number	Bit Name	Description			
7:0	PRD_STR	<ul> <li>Product String, UNICODE UTF-16LE per USB 2.0 Specification</li> <li>Maximum string length is 31 characters (62 bytes).</li> <li>Note: The string consists of individual 16-bit UNICODE UTF-16LE characters. The characters will be stored starting with the LSB at the least significant address and the MSB at the next 8-bit location (subsequent characters must be stored in sequential contiguous address in the same LSB, MSB manner). Some EEPROM programmers may transpose the MSB and LSB, thus reversing the byte order. Please pay careful attention to the byte ordering for your selected programming tools.</li> </ul>			

## 7.2.1.25 Register 92h-CFh: Serial String

Bit Number	Bit Name	Description
7:0	SER_STR	Serial String, UNICODE UTF16LE per USB 2.0 Specification Maximum string length is 31 characters (62 bytes).
		<b>Note:</b> The string consists of individual 16-bit UNICODE UTF-16LE characters. The characters will be stored starting with the LSB at the least significant address and the MSB at the next 8-bit location (subsequent characters must be stored in sequential contiguous address in the same LSB, MSB manner). Some EEPROM programmers may transpose the MSB and LSB, thus reversing the byte order. Please pay careful attention to the byte ordering for your selected programming tools.

## 7.2.1.26 Register F6h: Boost\_Up

Bit Number	Bit Name	Description			
7:2	Reserved	Reserved			
1:0	BOOST_IOUT	USB electrical signaling drive strength Boost Bit for Upstream Port. '00' = Normal electrical drive strength = No boost '01' = Elevated electrical drive strength = Low (approximately 4% boost) '10' = Elevated electrical drive strength = Medium (approximately 8% boost) '11' = Elevated electrical drive strength = High (approximately 12% boost)			
		<b>Note:</b> "Boost" could result in non-USB Compliant parameters, the OEM should use a '00' value unless specific implementation issues require additional signal boosting to correct for degraded USB signaling levels.			

## 7.2.1.27 Register F8h: Boost\_4:0

Bit Number	Bit Name	Description			
7:6	BOOST_IOUT_4	Upstream USB electrical signaling drive strength Boost Bit for Downstream Port '4'.			
		<ul> <li>'00' = Normal electrical drive strength = No boost</li> <li>'01' = Elevated electrical drive strength = Low (approximately 4% boost)</li> <li>'10' = Elevated electrical drive strength = Medium (approximately 8% boost)</li> <li>'11' = Elevated electrical drive strength = High (approximately 12% boost)</li> </ul>			
		<b>Note:</b> "Boost" could result in non-USB Compliant parameters, the OEM should use a '00' value unless specific implementation issues require additional signal boosting to correct for degraded USB signaling levels.			
5:4	BOOST_IOUT_3	USB electrical signaling drive strength Boost Bit for Downstream Port '3'.			
		<ul> <li>'00' = Normal electrical drive strength = No boost</li> <li>'01' = Elevated electrical drive strength = Low (approximately 4% boost)</li> <li>'10' = Elevated electrical drive strength = Medium (approximately 8% boost)</li> <li>'11' = Elevated electrical drive strength = High (approximately 12% boost)</li> </ul>			
		<b>Note:</b> "Boost" could result in non-USB Compliant parameters, the OEM should use a '00' value unless specific implementation issues require additional signal boosting to correct for degraded USB signaling levels.			

# USB82514

Bit Number	Bit Name	Description			
3:2	BOOST_IOUT_2	USB electrical signaling drive strength Boost Bit for Downstream Port '2'.			
		<ul> <li>'00' = Normal electrical drive strength = No boost</li> <li>'01' = Elevated electrical drive strength = Low (approximately 4% boost)</li> <li>'10' = Elevated electrical drive strength = Medium (approximately 8% boost)</li> <li>'11' = Elevated electrical drive strength = High (approximately 12% boost)</li> </ul>			
		<b>Note:</b> "Boost" could result in non-USB Compliant parameters, the OEM should use a '00' value unless specific implementation issues require additional signal boosting to correct for degraded USB signaling levels.			
1:0	BOOST_IOUT_1	USB electrical signaling drive strength Boost Bit for Downstream Port '1'. '00' = Normal electrical drive strength = No boost '01' = Elevated electrical drive strength = Low (approximately 4% boost)			
		<ul> <li>'10' = Elevated electrical drive strength = Medium (approximately 8% boost)</li> <li>'11' = Elevated electrical drive strength = High (approximately 12% boost)</li> </ul>			
		<b>Note:</b> "Boost" could result in non-USB Compliant parameters, the OEM should use a '00' value unless specific implementation issues require additional signal boosting to correct for degraded USB signaling levels.			

## 7.2.1.28 Register FAh: PortSwap

Bit Number	Bit Name	Description
7:0	PRTSP	<ul> <li>PortSwap: Swaps the upstream and downstream USB DP and DM Pins for ease of board routing to devices and connectors.</li> <li>'0' = USB D+ functionality is associated with the DP pin and D- functionality is associated with the DM pin.</li> <li>'1' = USB D+ functionality is associated with the DM pin and D- functionality is associated with the DP pin.</li> <li>Bit 7 = Reserved</li> <li>Bit 6 = Reserved</li> <li>Bit 5 = Reserved</li> <li>Bit 5 = Reserved</li> <li>Bit 4 = '1'; Port 4 DP/DM is swapped.</li> <li>Bit 2 = '1'; Port 2 DP/DM is swapped.</li> <li>Bit 1 = '1'; Port 1 DP/DM is swapped.</li> <li>Bit 0 = '1'; Upstream Port DP/DM is swapped.</li> </ul>

## 7.2.1.29 Register FBh: PortMap 12

Bit Number	Bit Name	DescriptionPortMap register for ports 1 & 2When a hub is enumerated by a USB host controller, the hub is only permitted to report how many ports it has; the hub is not permitted to select a numerical range or assignment. The host controller will number the downstream ports of the hub starting with the number '1' up to the number of ports that the hub rec- 			
7:0	PRTR12				
		TABLE 7-2	-	TMAP REGISTER FOR PORTS 1 & 2	
		Bit [7:4]	,0000,	Physical Port 2 is disabled	
			'0001'	Physical Port 2 is mapped to Logical Port 1	
			'0010'	Physical Port 2 is mapped to Logical Port 2	
		-	'0011'	Physical Port 2 is mapped to Logical Port 3	
			'0100'	Physical Port 2 is mapped to Logical Port 4	
			'0101' to '1111'	Illegal; Do Not Use	
		Bit [3:0]	'0000'	Physical Port 1 is disabled	
			'0001'	Physical Port 1 is mapped to Logical Port 1	
			'0010'	Physical Port 1 is mapped to Logical Port 2	
			'0011'	Physical Port 1 is mapped to Logical Port 3	
			'0100'	Physical Port 1 is mapped to Logical Port 4	
			'0101' to '1111'	Illegal; Do Not Use	

<sup>© 2014-2017</sup> Microchip Technology Inc.

## 7.2.1.30 Register FCh: PortMap 34

Bit Number	Bit Name			Description		
7:0	PRTR34	PortMap register for ports 3 & 4				
		When a hub is enumerated by a USB host controller, the hub is only permitted to report how many ports it has; the hub is not permitted to select a numerical range or assignment. The host controller will number the downstream ports of the hub starting with the number '1' up to the number of ports that the hub recognizes.				
		port on the hub is enabled (see PR	the "phys TMAP_EN n port num	eferred to as "logical port number" and the physical ical port number". When remapping mode is in Register 08h: Configuration Data Byte 3) the obers can be remapped to different logical port nost).		
		used, this e	, starting fro	e ensure that contiguous logical port numbers are om #1 up to the maximum number of enabled ports; at the hub's ports are numbered in accordance with will communicate with the ports.		
		TABLE 7-3:	PORTM	AP REGISTER FOR PORTS 3 & 4		
		Bit [7:4]	ʻ0000'	Physical Port 4 is disabled		
			'0001'	Physical Port 4 is mapped to Logical Port 1		
			'0010'	Physical Port 4 is mapped to Logical Port 2		
			'0011'	Physical Port 4 is mapped to Logical Port 3		
			'0100'	Physical Port 4 is mapped to Logical Port 4		
			'0101 to '1111'	Illegal: Do Not Use		
		Bit [3:0]	ʻ0000'	Physical Port 3 is disabled		
			'0001'	Physical Port 3 is mapped to Logical Port 1		
			'0010'	Physical Port 3 is mapped to Logical Port 2		
			'0011'	Physical Port 3 is mapped to Logical Port 3		
			ʻ0100'	Physical Port 3 is mapped to Logical Port 4		
			'0101 to '1111'	Illegal; Do Not Use		
			1			

7.2.1.31 Register FFh: Status/Commar
--------------------------------------

Bit Number	Bit Name	Description
7:3	Reserved	Reserved
2	INTF_PW_DN	SMBus Interface Power Down '0' = Interface is active '1' = Interface power down after ACK has completed
1	RESET	Reset the SMBus Interface and internal memory back to RESET_N assertion default settings. '0' = Normal Run/Idle State '1' = Force a reset of registers to their default state
0	USB_ATTACH	USB Attach (and write protect) '0' = SMBus slave interface is active '1' = Hub will signal a USB attach event to an upstream device. The internal memory (address range 00h-FEh) is "write-protected" to prevent unintentional data corruption.

## 7.2.2 I<sup>2</sup>C EEPROM

The I<sup>2</sup>C EEPROM interface implements a subset of the I<sup>2</sup>C Master Specification (Please refer to the Philips Semiconductor Standard I<sup>2</sup>C-Bus Specification for details on I<sup>2</sup>C bus protocols). The hub's I<sup>2</sup>C EEPROM interface is designed to attach to a single "dedicated" I<sup>2</sup>C EEPROM, and conforms to the Standard-mode I<sup>2</sup>C Specification (100 kbit/s transfer rate and 7-bit addressing) for protocol and electrical compatibility.

**Note:** Extensions to the I<sup>2</sup>C Specification are not supported. The hub acts as the master and generates the serial clock SCL, controls the bus access (determines which device acts as the transmitter and which device acts as the receiver), and generates the START and STOP conditions.

#### 7.2.2.1 Implementation Characteristics

The hub will only access an EEPROM using the sequential read protocol.

#### 7.2.2.2 Pull-Up Resistor

The circuit board designer is required to place external pull-up resistors (10 k $\Omega$  recommended) on the SDA/SMBDATA/ NON\_REM1 and SCL/SMBCLK/CFG\_SEL0 lines (per SMBus 1.0 Specification, and EEPROM manufacturer guidelines) to VDD in order to assure proper operation.

#### 7.2.2.3 I<sup>2</sup>C EEPROM Slave Address

Slave address is 1010000.

**Note:** 10-bit addressing is NOT supported.

#### 7.2.3 IN-CIRCUIT EEPROM PROGRAMMING

The EEPROM can be programmed via ATE (Automatic Test Equipment) by pulling RESET\_N low (which tri-states the hub's EEPROM interface and allows an external source to program the EEPROM).

<sup>© 2014-2017</sup> Microchip Technology Inc.

### 7.3 SMBus Slave Interface

Instead of loading user-defined descriptor data from an external EEPROM, the Microchip hub can be configured to receive a code load from an external processor via an SMBus interface. The SMBus interface shares the same pins as the EEPROM interface; if CFG\_SEL1 & CFG\_SEL0 activates the SMBus interface, external EEPROM support is no longer available (and the user-defined descriptor data must be downloaded via the SMBus). The Microchip hub waits indefinitely for the SMBus code load to complete and only "appears" as a newly connected device on USB after the code load is completed.

The hub's SMBus implementation is a *slave-only* SMBus device. The implementation only supports read block and write block protocols. The hub responds to other protocols as described in Section 7.3.2, "Invalid Protocol Response Behavior," on page 33. Reference to the System Management Bus Specification, Rev 1.0.

The SMBus interface is used to read and write the registers in the device. The register set is shown in Section 7.2.1, "Internal Register Set (Common to EEPROM and SMBus)," on page 16.

#### 7.3.1 BUS PROTOCOLS

Typical write block and read block protocols are shown below. Register accesses are performed using 7-bit slave addressing, an 8-bit register address field, and an 8-bit data field. The shading indicates the hub driving data on the SMBDATA line; otherwise, host data is on the SDA/SMBDATA/NON\_REM1 line.

The slave address is the unique SMBus Interface Address for the hub that identifies it on SMBus. The register address field is the internal address of the register to be accessed. The register data field is the data that the host is attempting to write to the register or the contents of the register that the host is attempting to read.

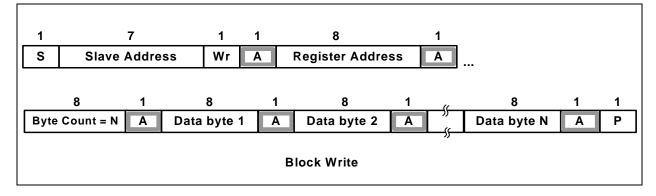
**Note:** Data bytes are transferred MSB first.

#### 7.3.1.1 Block Read/Write

The block write begins with a slave address and a write condition. After the command code, the host issues a byte count, which describes how many more bytes will follow in the message. If a slave had 20 bytes to send, the first byte would be the number 20 (14h), followed by the 20 bytes of data. The byte count may not be 0. A block read or write is allowed to transfer a maximum of 32 data bytes.

Denotes Master-to-Slave Denotes Slave-to-Master
---

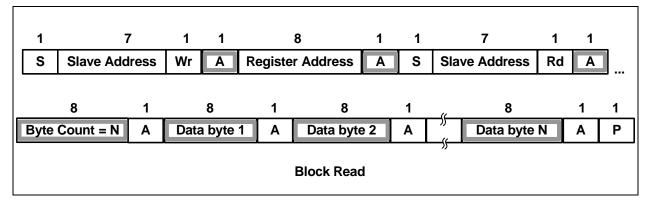
#### FIGURE 7-1: BLOCK WRITE



#### 7.3.1.2 Block Read

A block read differs from a block write in that the repeated start condition exists to satisfy the I<sup>2</sup>C specification's requirement for a change in the transfer direction.





#### 7.3.2 INVALID PROTOCOL RESPONSE BEHAVIOR

Registers accessed with an invalid protocol are not updated. A register is only updated following a valid protocol. The only valid protocols are write block and read block, which are described above.

The hub only responds to the hardware selected Slave Address (0101100x).

Attempting to communicate with the hub over SMBus with an invalid slave address or invalid protocol results in no response, and the SMBus Slave Interface returns to the idle state.

The only valid registers that are accessible by the SMBus slave address are the registers defined in the Registers Section. The hub does not respond to undefined registers.

#### 7.3.3 GENERAL CALL ADDRESS RESPONSE

The hub does not respond to a general call address of 0000\_000b.

#### 7.3.4 SLAVE DEVICE TIME-OUT

According to the SMBus Specification, version 1.0 devices in a transfer can abort the transfer in progress and release the bus when any single clock low interval exceeds 25 ms ( $T_{TIMEOUT, MIN}$ ). Devices that have detected this condition must reset their communication and be able to receive a new START condition no later than 35 ms ( $T_{TIMEOUT, MAX}$ ).

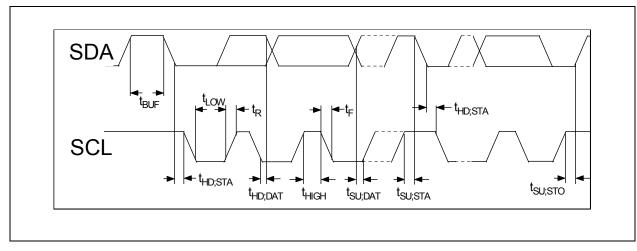
**Note:** Some simple devices do not contain a clock low drive circuit; this simple kind of device typically resets its communications port after a start or stop condition. The slave device time-out must be implemented.

#### 7.3.5 STRETCHING THE SCLK SIGNAL

The hub supports stretching of the SCLK by other devices on the SMBus. The hub does not stretch the SCLK.

## 7.3.6 SMBus/I<sup>2</sup>C TIMING

The SMBus slave interface complies with the SMBus AC Timing Specification.



# FIGURE 7-3: SMBus/I<sup>2</sup>C TIMING PARAMETERS

Symbol	Parameter	Min	Тур	Max	Unit
fSCL	SCL Clock Frequency	-	-	100	kHz
tBUF	Bus Free Time	4.7	-	-	μs
tSU;STA	START Condition Set-Up Time	4.7	-	-	μs
tHD;STA	START Condition Hold Time	4.0	-	-	μs
tLOW	SCL LOW Time	4.7	-	-	μs
tHIGH	SCL HIGH Time	4.0	-	-	μs
tR	SCL and SDA Rise Time	-	-	1.0	μs
tF	SCL and SDA Fall Time	-	-	0.3	μs
tSU;DAT	Data Set-Up Time	0.25	-	-	μs
tHD;DAT	Data Hold Time	0.25	-	-	μs
tSU;STO	STOP Condition Set-Up Time	4.0	-	-	μs

## 7.3.7 BUS RESET SEQUENCE

The SMBus slave interface resets and returns to the idle state upon a START field followed immediately by a STOP field.

## 7.3.7.1 Undefined Registers

The registers shown in Table 7-2 are the defined registers in the hub. Reads to undefined registers return to 00h. Writes to undefined registers have no effect and do not return an error.

#### 7.3.7.2 Reserved Registers

Only a '0' should be written to all reserved registers or bits.

### 7.4 Default Configuration Option

To configure the hub in its default configuration, strap the CFG\_SEL1 to 0 and CFG\_SEL0 to 0. This configures the hub to the internal defaults and enables the strapping options. (Please see Section 7.2.1, "Internal Register Set (Common to EEPROM and SMBus)" for the list of the default values.) For specific pin strapping options, please see Chapter 6.0, Pin Descriptions for instructions on how to modify the default values. Options include port disable and non-removable pin strapping.

#### 7.5 Reset

There are two different resets that the hub experiences. One is a hardware reset via the external RESET\_N pin and the second is via the USB Bus Reset.

#### 7.5.1 EXTERNAL HARDWARE RESET\_N

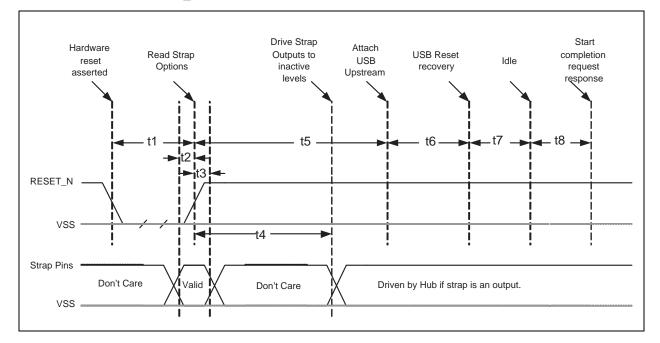
A valid hardware reset is defined as assertion of RESET\_N for a minimum of 1 $\mu$ s after all power supplies are within operating range. While reset is asserted, the hub (and its associated external circuitry) consumes less than 500  $\mu$ A of current from the upstream USB power source.

Assertion of RESET\_N (external pin) causes the following:

- 1. All downstream ports are disabled, and PRTPWR power to downstream devices is removed.
- 2. The PHYs are disabled, and the differential pairs will be in a high-impedance state.
- 3. All transactions immediately terminate; no states are saved.
- 4. All internal registers return to the default state (in most cases, 00(h)).
- 5. The external crystal oscillator is halted.
- 6. The PLL is halted.

The hub is "operational" 500 µs after RESET\_N is negated. Once operational, the hub configures itself based on the settings of pins CFG\_SEL[1:0]. See Table 7-1, "Hub Configuration Options," on page 15.

#### FIGURE 7-4: RESET N TIMING FOR DEFAULT/STRAP OPTION MODE



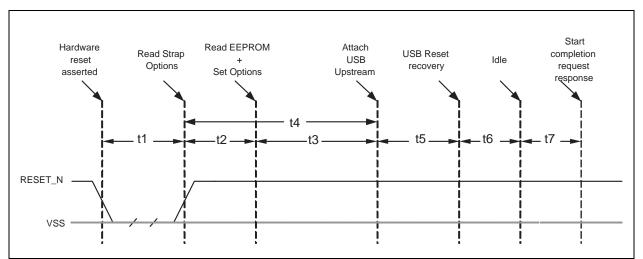
<sup>© 2014-2017</sup> Microchip Technology Inc.

Name	Description	Min	Тур	Max	Unit
t1	RESET_N Asserted	1	-	-	µsec
t2	Strap Setup Time	16.7	-	-	nsec
t3	Strap Hold Time	16.7	-	1400	nsec
t4	Hub outputs driven to inactive logic states	-	1.5	2	µsec
t5	USB Attach (see Note 1: and 2:)	-	-	100	msec
t6	Host acknowledges attach and signals USB Reset	100	-	-	msec
t7	USB Idle	-	undefined	-	msec
t8	Completion time for requests (with or without data stage)	-	-	5	msec

**Note 1:** In bus-powered mode, the hub and its associated circuitry must not consume more than 100 mA from the upstream USB power source during t1+t5.

2: All power supplies must have reached the operating levels mandated in Chapter 8.0, DC Parameters prior to (or coincident with) the assertion of RESET\_N.

#### 7.5.1.1 RESET\_N for EEPROM Configuration



#### FIGURE 7-5: RESET\_N TIMING FOR EEPROM MODE

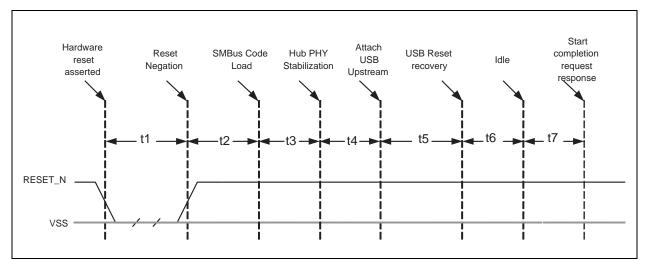
Name	Description	Min	Тур	Max	Units
t1	RESET_N Asserted	1	-	-	µsec
t2	Hub Recovery/Stabilization	-	-	500	µsec
t3	EEPROM Read / Hub Config	-	2.0	99.5	msec
t4	USB Attach (see Note 1: and 2:)	-	-	100	msec
t5	Host acknowledges attach and signals USB Reset	100	-	-	msec
t6	USB Idle	-	undefined	-	msec
t7	Completion time for requests (with or without data stage)	-	-	5	msec

**Note 1:** When in bus-powered mode, the hub and its associated circuitry must not consume more than 100 mA from the upstream USB power source during t4+t5+t6+t7.

2: All power supplies must have reached the operating levels mandated in Chapter 8.0, DC Parameters, prior to (or coincident with) the assertion of RESET\_N.

# USB82514

#### 7.5.1.2 RESET\_N for SMBus Slave Configuration



#### FIGURE 7-6: RESET\_N TIMING FOR SMBUS MODE

Name	Description	Min	Тур	Max	Units
t1	RESET_N Asserted	1	-	-	µsec
t2	Hub Recovery/Stabilization	-	-	500	µsec
t3	SMBus Code Load	-	250	300	msec
t4	Hub Configuration and USB Attach (see Note 1: and 2:)	-	-	100	msec
t5	Host acknowledges attach and signals USB Reset	100	-	-	msec
t6	USB Idle	-	Undefined	-	msec
t7	Completion time for requests (with or without data stage)	-	-	5	msec

**Note 1:** For bus-powered configurations the maximum time is 99.5 ms, and the hub and its associated circuitry must not consume more than 100 mA from the upstream USB power source during t2+t3+t4+t5+t6+t7. For Self-Powered configurations, t3 MAX is not applicable and the time to load the configuration is determined by the external SMBus host.

2: All power supplies must have reached the operating levels mandated in Chapter 8.0, DC Parameters, prior to (or coincident with) the assertion of RESET\_N.

#### 7.5.2 USB BUS RESET

In response to the upstream port signaling a reset to the hub, the hub does the following:

- 1. Sets default bus address to '0'.
- 2. Sets configuration to: Unconfigured.
- 3. Negates PRTPWR[4:1] to all downstream ports.
- 4. Clears all TT buffers.
- 5. Moves device from suspended to active (if suspended).
- Complies with Section 11.10 of the USB 2.0 Specification for behavior after completion of the reset sequence. The host then configures the hub and the hub's downstream port devices in accordance with the USB Specification.

Note: The hub does not propagate the upstream USB reset to downstream devices.

DS60001234C-page 38

## 8.0 DC PARAMETERS

#### 8.1 Maximum Guaranteed Ratings

Parameter	Symbol	Min	Мах	Units	Comments
Storage Tem- perature	T <sub>STOR</sub>	-55	150	°C	-
3.3 V supply voltage	V <sub>DDA33,</sub> V <sub>DD33PLL,</sub> V <sub>DD33</sub>	-0.5	4.0	V	-
Voltage on any I/O pin	-	-0.5	V <sub>DD33</sub> + 0.3	V	-
Voltage on XTAL1	-	-0.5	3.6	V	-
Voltage on XTAL2	-	-0.5	2.0	V	-

**Note 1:** Stresses above the specified parameters could cause permanent damage to the device. This is a stress rating only and functional operation of the device at any condition above those indicated in the operation sections of this specification is not implied.

2: When powering this device from laboratory or system power supplies, it is important that the Absolute Maximum Ratings not be exceeded or device failure can result. Some power supplies exhibit voltage spikes on their outputs when the AC power is switched on or off. In addition, voltage transients on the AC power line may appear on the DC output. When this possibility exists, it is suggested to use a clamp circuit.

<sup>© 2014-2017</sup> Microchip Technology Inc.

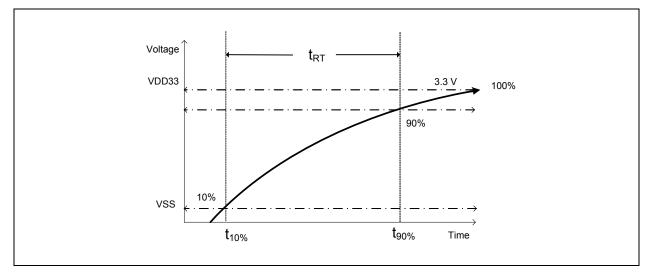
## 8.2 Operating Conditions

Parameter	Symbol	Min	Мах	Units	Comments
36-pin package Operating Temperature	Τ <sub>Α</sub>	-40	85	°C	Ambient temperature in still air. (See Note 1: )
3.3 V supply voltage	V <sub>DDA33</sub> V <sub>DD33PLL</sub> V <sub>DD33</sub>	3.0	3.6	V	-
3.3 V supply rise time	t <sub>RT</sub>	-	400	μs	(See Figure 8-1, "Supply Rise Time Models") (See 2: )
Voltage on any I/O pin	-	-0.3	3.6	V	If any 3.3 V supply voltage drops below 3.0 V, then the MAX becomes: (3.3 V supply voltage) + 0.5 V
Voltage on XTAL1	-	-0.3	2.0	V	-
Voltage on XTAL2	-	-0.3	2.0	V	-

Note 1: The  $T_i$  (junction temperature) must not exceed 125°C.

2: The rise time for the 3.3 V supply can be extended to 500 ms max if RESET\_N is actively driven low, typically by another IC, until 1 µs after all supplies are within operating range.

#### FIGURE 8-1: SUPPLY RISE TIME MODELS



#### 8.3 Package Thermal Specifications

#### TABLE 8-1:36-PIN QFN PACKAGE THERMAL PARAMETERS

Parameter	Symbol	Value	Unit	Comments
Thermal Resistance	$\Theta_{JA}$	39	°C/W	Measured from the die to the ambient air.
Junction-to-Top-of-Package	$\Psi_{JT}$	0.3	°C/W	-

**Note:** Thermal parameters are measured or estimated for devices with the exposed pad soldered to thermal vias in a multilayer 2S2P PCB per JESD51.

#### 8.4 DC Electrical Characteristics

#### TABLE 8-2: DC ELECTRICAL CHARACTERISTICS

Parameter	Symbol	Min	Тур	Мах	Units	Comments
I, IS Type Input Buffer	-	-	-	-	-	
Low Input Level	V <sub>ILI</sub>	-	-	0.8	V	TTL Levels
High Input Level	V <sub>IHI</sub>	2.0	-	-	V	
Input Leakage	Ι <sub>ΙL</sub>	-10	-	+10	μA	$V_{IN} = 0$ to $V_{DD33}$
Hysteresis ('IS' Only)	V <sub>HYSI</sub>	250	-	600	mV	
Input Buffer with Pull-Up (IPU)						
Low Input Level	V <sub>ILI</sub>	-	-	0.8	V	TTL Levels
High Input Level	V <sub>IHI</sub>	2.0	-	-	V	-
Low Input Leakage	I <sub>ILL</sub>	+20	-	+110	μA	V <sub>IN</sub> = 0
High Input Leakage	I <sub>IHL</sub>	-10	-	+10	μA	V <sub>IN</sub> = V <sub>DD33</sub>
IPU Buffer Float Voltage	V <sub>IPUF</sub>		2.0		V	Voltage at the IPU pin when floated. (Note 3:)
Input Buffer with Pull- Down (IPD)						
Low Input Level	V <sub>ILI</sub>	-	-	0.8	V	TTL Levels
High Input Level	V <sub>IHI</sub>	2.0	-		V	-
Low Input Leakage	I <sub>ILL</sub>	+10	-	-10	μA	V <sub>IN</sub> = 0
High Input Leakage	I <sub>IHL</sub>	-20	-	-100	μA	V <sub>IN</sub> = V <sub>DD33</sub>

<sup>© 2014-2017</sup> Microchip Technology Inc.

#### TABLE 8-2: DC ELECTRICAL CHARACTERISTICS (CONTINUED)

Parameter	Symbol	Min	Тур	Max	Units	Comments
ICLK Input Buffer						
Low Input Level	V <sub>ILCK</sub>	-	-	0.5	V	-
High Input Level	V <sub>IHCK</sub>	1.4	-	-	V	-
Input Leakage	IIL	-10	-	+10	μA	V <sub>IN</sub> = 0 to V <sub>DD33</sub>
O12, I/O12 & I/OSD12 Type Buffer						
Low Output Level	V <sub>OL</sub>	-	-	0.4	V	I <sub>OL</sub> = 12 mA @ V <sub>DD33</sub> = 3.3 V
High Output Level	V <sub>OH</sub>	2.4	-	-	V	I <sub>OH</sub> = -12 mA @ V <sub>DD33</sub> = 3.3 V
Output Leakage	I <sub>OL</sub>	-10	-	+10	μA	$V_{IN} = 0$ to $V_{DD33}$
Hysteresis ('SD' pad only)	V <sub>HYSC</sub>	250	-	600	mV	(Note 1:)
IO-U ( Note 2:)	-	-	-	-	-	-
USB82514						
Supply Current Unconfigured						
Hi-Speed Host Full-Speed Host	I <sub>CCINTHS</sub> I <sub>CCINTFS</sub>	-	85 72	100 -	mA mA	No device connected
Supply Current Configured (Hi-Speed Host)						All supplies combined
1 Port @ HS 2 Ports @ HS 3 Ports @ HS 4 Ports @ HS	I <sub>НСН1</sub> I <sub>НСН2</sub> I <sub>НСН3</sub> I <sub>НСН4</sub>	- - -	225 255 260 260	- - - 300	mA mA mA mA	Device connected
Supply Current Configured (Full-Speed Host)						All supplies combined
1 Port @ FS 2 Ports @ FS 3 Ports @ FS 4 Ports @ FS	I <sub>НСН1</sub> I <sub>НСН2</sub> I <sub>НСН3</sub> I <sub>НСН4</sub>	- - -	150 160 160 160	- - -	mA mA mA mA	
Supply Current Suspend	I <sub>CSBY</sub>	-	325	-	μA	All supplies combined
Supply Current Reset	I <sub>CRST</sub>	-	115	-	μA	All supplies combined

**Note 1:** Output leakage is measured with the current pins in high impedance.

2: See USB 2.0 Specification for USB DC Electrical Characteristics.

**3:** When the IPU type pin is floated, the internal logic will interpret this as logic high. IPU buffer pins include an internal pull up and level shifter. IPU pins float to ~2.0 V with external loads less than 10 μA. This ensures the internal level shifted voltage is above the high level threshold for the internal logic.

### 8.5 Capacitance

TA = 25°C; fc = 1 MHz; VDD33 = 3.3 V

#### TABLE 8-3: PIN CAPACITANCE

		Limits				
Parameter	Symbol	Min	Тур	Max	Unit	Test Condition
Clock Input Capacitance	C <sub>XTAL</sub>	-	-	2	pF	All pins except USB pins (and pins under test tied to AC ground)
Input Capacitance	C <sub>IN</sub>	-	-	10	pF	
Output Capacitance	C <sub>OUT</sub>	-	-	20	pF	

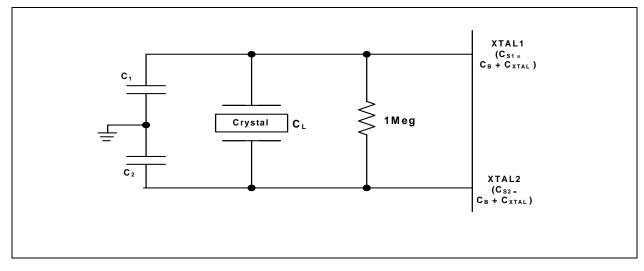
<sup>© 2014-2017</sup> Microchip Technology Inc.

## 9.0 AC SPECIFICATIONS

## 9.1 Oscillator/Clock

Crystal: Parallel Resonant, Fundamental Mode, 24 MHz  $\pm$  350 ppm. External Clock: 50% Duty cycle  $\pm$  10%, 24 MHz  $\pm$  350 ppm, Jitter < 100 ps rms.

## FIGURE 9-1: TYPICAL CRYSTAL CIRCUIT



Note: C<sub>B</sub> equals total board/trace capacitance.

## FIGURE 9-2: FORMULA TO FIND VALUE OF C<sub>1</sub> AND C<sub>2</sub>

$$C_{L} = \frac{(C_{1} + C_{S1}) \times (C_{2} + C_{S2})}{(C_{1} + C_{S1} + C_{2} + C_{S2})}$$

#### 9.1.1 SMBus INTERFACE

The Microchip hub is designed to meet the specifications as set forth in the SMBus 1.0 Specification for Slave-Only devices (except as noted in Section 7.3, "SMBus Slave Interface").

#### 9.1.2 I<sup>2</sup>C EEPROM

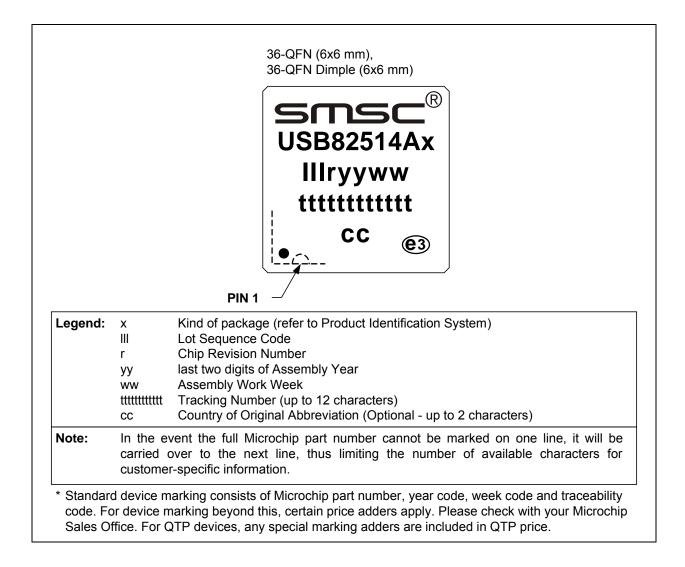
Frequency is fixed at 60 kHz  $\pm$  20%.

#### 9.1.3 USB 2.0

The Microchip hub is designed to comply with the USB 2.0 Specification (Revision 2.0 from April 27, 2000 and the 12/7/2000 and 5/28/2002 Errata). Please refer to the USB 2.0 Specification for more information.

## **10.0 PACKAGE INFORMATION**

#### **10.1** Package Marking Information



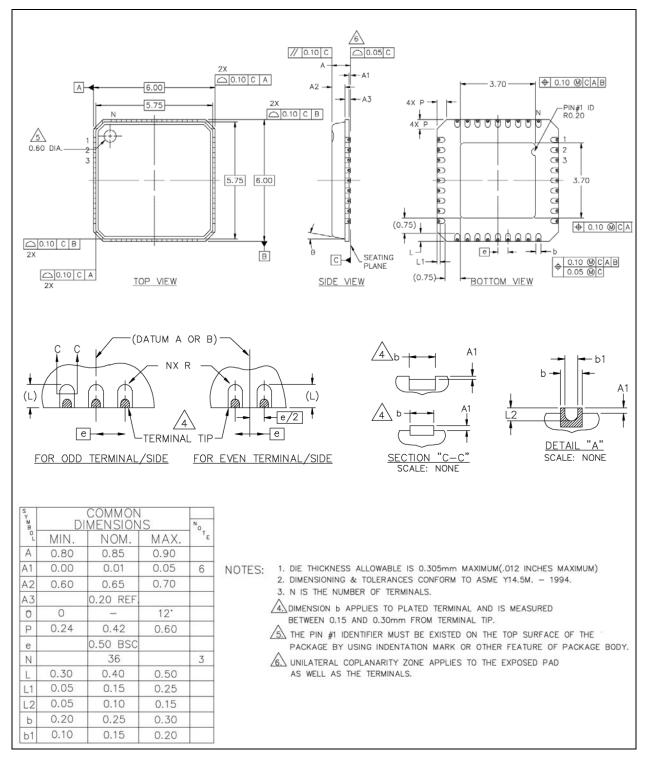
<sup>© 2014-2017</sup> Microchip Technology Inc.

# USB82514

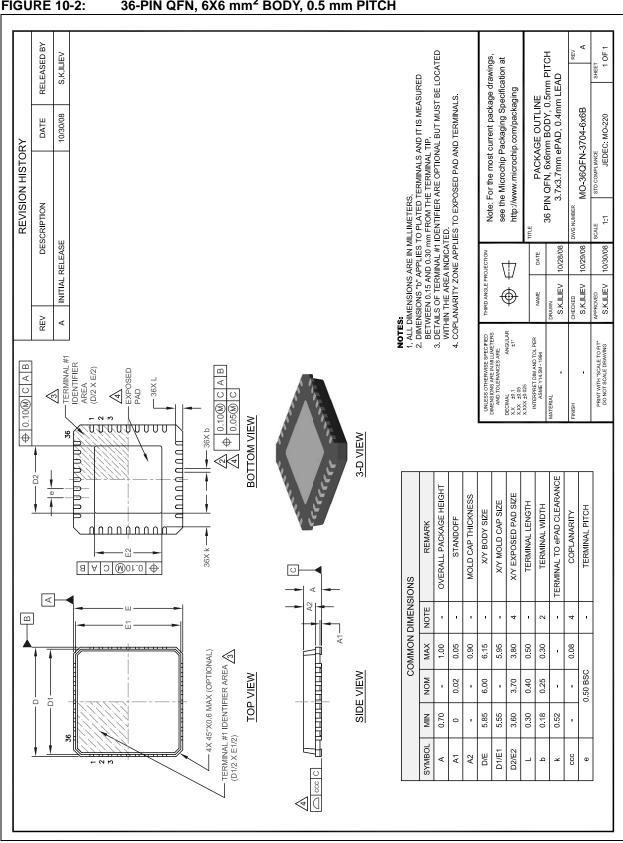
#### 10.2 Package Drawings

**Note:** For the most current package drawings, see the Microchip Packaging Specification at: http://www.microchip.com/packaging.





# **USB82514**



## APPENDIX A: DATA SHEET REVISION HISTORY

#### TABLE A-1: CUSTOMER REVISION HISTORY

REVISION LEVEL & DATE	SECTION/FIGURE/ENTRY	CORRECTION		
DS60001234C (02-01-17)	Product Identification System	Adopted according to new system.		
	Chapter 3.0, Pin Configuration	Package marking information (legend) moved to Chapter 10.0, Package Information		
	Chapter 10.0, Package Information	New section Section 10.1, "Package Marking Information"		
DS60001234B (06-04-14)	All	Version migrated to Microchip template		
	Cover Sheet	Trueauto remark removed, dimple package added		
	Chapter 3.0, Pin Configuration	Figure 3-1 improved: USB82514AM -> USB82514Ax (generalized description), added in legend		
	Chapter 10.0, Package Information	Normal QFN package (no dimple) corrected (56 pins -> 36 pins)		
DS60001234A (10-04-13)	All	Microchip DS number inserted. Revision A replaces the previous SMSC version Rev. 1.4 Trademark and last page according to Microchip guidelines. SMSC branding removed		
	Page 2	Order numbers added for both packages		
	Chapter 3.0, Pin Configuration	PB free information removed in Figure 3-1.		
	Chapter 10.0, Package Information	New version includes both packages		
Rev. 1.4 (08-14-13)	Chapter 10.0, Package Information	New package added		
Rev. 1.3 (06-10-13)	All	Order numbers modified according to Microchip guideline.		
	All	'Lead-free' remark removed in the document		
Rev. 1.3 (04-04-13)	Section 7.2.1.14, "Register 0Dh: Max Power for Bus- Powered Operation"	Added sentence: A value of 50 (decimal) indicates 100 mA, which is the default value.		
	Section 7.2.1.15, "Register 0Eh: Hub Controller Max Current for Self-Powered Operation"	Removed sentence: A value of 50 (decimal) indicates 100 mA, which is the default value.		
	Section 8.1, "Maximum Guaranteed Ratings"	Row 3.3 V supply voltage: Min value added: -0.5 V		
Rev. 1.2	All	Microchip style implemented (logo and legend).		
(09-26-12)	Section 7.5.1, "External Hardware RESET_N"	CFG_SEL[2:0] -> CFG_SEL[1:0]		

<b>REVISION LEVEL &amp; DATE</b>	SECTION/FIGURE/ENTRY	CORRECTION
Rev. 1.1 (11-18-11)	Section 8.4, "DC Electrical Characteristics"	V <sub>IPUF</sub> (IPU Buffer Float Voltage) added in Table 8- 3.
Rev. 1.1 (11-17-11)	Chapter 3.0, Pin Configuration	Figure 3-1 improved:
Rev. 1.1 (11-09-11)	Chapter 3.0, Pin Configuration	Topmark information added in Figure 3-1. Package designators described.
	Section 8.2, "Operating Conditions"	Max value corrected for 'voltage on any I/O pin': 3.6 V
	Section 8.5, "Capacitance"	VDD18, VDDPLL 0 1.8 V replaced by VDD33 = 3.3 V
Rev. 1.1 (07-19-11)	Section 8.2, "Operating Conditions"	In the table: Added Note 8.4 under Note 8.3. Added reference to Note 8.4 in the comments column for 3.3 V rise time parameter.
Rev. 1.1 (05-30-11)	Chapter 6.0, Pin Descriptions	VBUS_DET is an input. Buffer type changed from "I/O12" to "I".
Rev. 1.1 (05-04-11)	Section 8.2, "Operating Conditions"	Max value corrected for XTAL1 and XTAL2: 2.0 V
Rev. 1.1 (03-21-11)	Chapter 6.0, Pin Descriptions	The internal regulator cannot be turned off.
	Section 8.1, "Maximum Guaranteed Ratings"	The chip does not have an external 1.8 V supply. Max value of 3.3 V supply voltages changed from 4.6 V to 4.0 V.
	Section 8.2, "Operating Conditions"	The chip does not have an external 1.8 V supply.
Rev. 1.0 (10-19-10)	Section 8.1, "Maximum Guaranteed Ratings"	Max value corrected for 'voltage on any I/O pin': 5.5 -> $V_{DD33}$ + 0.3
Rev. 1.0 (10-12-10)	Page 2	Order information completed.
Rev. 1.0 (09-02-09)	Section 8.3, "Package Thermal Specifications"	TBD values have been specified.
Rev. 0.8 (08-28-09)	Section 8.4, "DC Electrical Characteristics"	TBD values have been specified.
Rev. 0.7 (03-13-09)	All	Confidential designation removed from document.
Rev. 0.7 (12-01-08)	Initial Release	

TABLE A-1: CUSTOMER REVISION HISTORY (CONTINUED
---

<sup>© 2014-2017</sup> Microchip Technology Inc.

## THE MICROCHIP WEB SITE

Microchip provides online support via our WWW site at www.microchip.com. This web site is used as a means to make files and information easily available to customers. Accessible by using your favorite Internet browser, the web site contains the following information:

- **Product Support** Data sheets and errata, application notes and sample programs, design resources, user's guides and hardware support documents, latest software releases and archived software
- **General Technical Support** Frequently Asked Questions (FAQ), technical support requests, online discussion groups, Microchip consultant program member listing
- Business of Microchip Product selector and ordering guides, latest Microchip press releases, listing of seminars and events, listings of Microchip sales offices, distributors and factory representatives

## CUSTOMER CHANGE NOTIFICATION SERVICE

Microchip's customer notification service helps keep customers current on Microchip products. Subscribers will receive e-mail notification whenever there are changes, updates, revisions or errata related to a specified product family or development tool of interest.

To register, access the Microchip web site at www.microchip.com. Under "Support", click on "Customer Change Notification" and follow the registration instructions.

## **CUSTOMER SUPPORT**

Users of Microchip products can receive assistance through several channels:

- Distributor or Representative
- Local Sales Office
- Field Application Engineer (FAE)
- Technical Support

Customers should contact their distributor, representative or field application engineer (FAE) for support. Local sales offices are also available to help customers. A listing of sales offices and locations is included in the back of this document.

Technical support is available through the web site at: http://microchip.com/support

#### **PRODUCT IDENTIFICATION SYSTEM**

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

	[X]     X     [X]     -     X     -     (2)       T     T     T     T     T     T       Inperature     Package Tape and Reel     Pattern     Designator       Range     Option	Examples: a) USB82514AMR-A-V03 -40°C to + 85°C, QFN (36-pin), Tape & Reel,
Device:	USB82514	A, V03 b) USB82514AF-B-V06
Temperature Range:	$A = -40^{\circ}C \text{ to } +85^{\circ}C$	-40°C to + 85°C, QFN dimple package (36-pin), Tray, B,
Package:	M = QFN (36-pin) F = QFN Dimple Package (36-pin)	V06
Tape and Reel Option:	Blank = Standard packaging (tray) R = Tape and Reel <sup>(1)</sup>	Note 1: Tape and Reel identifier only appears in the
Pattern:	A = Product Version B = Product Version	catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check with your Microchip Sales Office for package
Designator:	Vxx = Automotive Designator	availability with the Tape and Reel option. <b>Note 2:</b> "-" is optional. Check with your Microchip Sales Office for exact ordering part number.

<sup>© 2014-2017</sup> Microchip Technology Inc.

#### Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION, QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights unless otherwise stated.

#### Trademarks

The Microchip name and logo, the Microchip logo, AnyRate, AVR, AVR logo, AVR Freaks, BeaconThings, BitCloud, CryptoMemory, CryptoRF, dsPIC, FlashFlex, flexPWR, Heldo, JukeBlox, KEELOQ, KEELOQ logo, Kleer, LANCheck, LINK MD, maXStylus, maXTouch, MediaLB, megaAVR, MOST, MOST logo, MPLAB, OptoLyzer, PIC, picoPower, PICSTART, PIC32 logo, Prochip Designer, QTouch, RightTouch, SAM-BA, SpyNIC, SST, SST Logo, SuperFlash, tinyAVR, UNI/O, and XMEGA are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

ClockWorks, The Embedded Control Solutions Company, EtherSynch, Hyper Speed Control, HyperLight Load, IntelliMOS, mTouch, Precision Edge, and Quiet-Wire are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Adjacent Key Suppression, AKS, Analog-for-the-Digital Age, Any Capacitor, AnyIn, AnyOut, BodyCom, chipKIT, chipKIT logo, CodeGuard, CryptoAuthentication, CryptoCompanion, CryptoController, dsPICDEM, dsPICDEM.net, Dynamic Average Matching, DAM, ECAN, EtherGREEN, In-Circuit Serial Programming, ICSP, Inter-Chip Connectivity, JitterBlocker, KleerNet, KleerNet logo, Mindi, MiWi, motorBench, MPASM, MPF, MPLAB Certified logo, MPLIB, MPLINK, MultiTRAK, NetDetach, Omniscient Code Generation, PICDEM, PICDEM.net, PICkit, PICtail, PureSilicon, QMatrix, RightTouch logo, REAL ICE, Ripple Blocker, SAM-ICE, Serial Quad I/O, SMART-I.S., SQI, SuperSwitcher, SuperSwitcher II, Total Endurance, TSHARC, USBCheck, VariSense, ViewSpan, WiperLock, Wireless DNA, and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

Silicon Storage Technology is a registered trademark of Microchip Technology Inc. in other countries.

GestIC is a registered trademarks of Microchip Technology Germany II GmbH & Co. KG, a subsidiary of Microchip Technology Inc., in other countries.

All other trademarks mentioned herein are property of their respective companies.

© 2014-2017, Microchip Technology Incorporated, All Rights Reserved.

ISBN: 978-1-5224-1112-3

## QUALITY MANAGEMENT SYSTEM CERTIFIED BY DNV = ISO/TS 16949=

Microchip received ISO/TS-16949:2009 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona; Gresham, Oregon and design centers in California and India. The Company's quality system processes and procedures are for its PIC® MCUs and dsPIC® DSCs, KEELOQ® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001:2000 certified.

DS60001234C-page 52



## **Worldwide Sales and Service**

#### AMERICAS

Corporate Office 2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7200 Fax: 480-792-7277 Technical Support: http://www.microchip.com/

support Web Address: www.microchip.com

Atlanta Duluth, GA Tel: 678-957-9614 Fax: 678-957-1455

Austin, TX Tel: 512-257-3370

Boston Westborough, MA Tel: 774-760-0087 Fax: 774-760-0088

**Chicago** Itasca, IL Tel: 630-285-0071 Fax: 630-285-0075

**Dallas** Addison, TX Tel: 972-818-7423 Fax: 972-818-2924

**Detroit** Novi, MI Tel: 248-848-4000

Houston, TX Tel: 281-894-5983

Indianapolis Noblesville, IN Tel: 317-773-8323 Fax: 317-773-5453 Tel: 317-536-2380

Los Angeles Mission Viejo, CA Tel: 949-462-9523 Fax: 949-462-9608 Tel: 951-273-7800

Raleigh, NC Tel: 919-844-7510

New York, NY Tel: 631-435-6000 San Jose, CA

Tel: 408-735-9110 Tel: 408-436-4270

**Canada - Toronto** Tel: 905-695-1980 Fax: 905-695-2078

#### ASIA/PACIFIC

Asia Pacific Office Suites 3707-14, 37th Floor Tower 6. The Gateway

Harbour City, Kowloon Hong Kong Tel: 852-2943-5100 Fax: 852-2401-3431

Australia - Sydney Tel: 61-2-9868-6733 Fax: 61-2-9868-6755

**China - Beijing** Tel: 86-10-8569-7000 Fax: 86-10-8528-2104

**China - Chengdu** Tel: 86-28-8665-5511 Fax: 86-28-8665-7889

China - Chongqing Tel: 86-23-8980-9588 Fax: 86-23-8980-9500

China - Dongguan Tel: 86-769-8702-9880

China - Guangzhou Tel: 86-20-8755-8029

**China - Hangzhou** Tel: 86-571-8792-8115 Fax: 86-571-8792-8116

**China - Hong Kong SAR** Tel: 852-2943-5100

Fax: 852-2401-3431 China - Nanjing Tel: 86-25-8473-2460 Fax: 86-25-8473-2470

**China - Qingdao** Tel: 86-532-8502-7355 Fax: 86-532-8502-7205

**China - Shanghai** Tel: 86-21-3326-8000 Fax: 86-21-3326-8021

China - Shenyang Tel: 86-24-2334-2829 Fax: 86-24-2334-2393

**China - Shenzhen** Tel: 86-755-8864-2200 Fax: 86-755-8203-1760

**China - Wuhan** Tel: 86-27-5980-5300 Fax: 86-27-5980-5118

**China - Xian** Tel: 86-29-8833-7252 Fax: 86-29-8833-7256

#### ASIA/PACIFIC

**China - Xiamen** Tel: 86-592-2388138 Fax: 86-592-2388130

**China - Zhuhai** Tel: 86-756-3210040 Fax: 86-756-3210049

India - Bangalore Tel: 91-80-3090-4444 Fax: 91-80-3090-4123

**India - New Delhi** Tel: 91-11-4160-8631 Fax: 91-11-4160-8632

India - Pune Tel: 91-20-3019-1500

**Japan - Osaka** Tel: 81-6-6152-7160 Fax: 81-6-6152-9310

**Japan - Tokyo** Tel: 81-3-6880- 3770 Fax: 81-3-6880-3771

**Korea - Daegu** Tel: 82-53-744-4301 Fax: 82-53-744-4302

Korea - Seoul Tel: 82-2-554-7200 Fax: 82-2-558-5932 or 82-2-558-5934

Malaysia - Kuala Lumpur Tel: 60-3-6201-9857 Fax: 60-3-6201-9859

Malaysia - Penang Tel: 60-4-227-8870 Fax: 60-4-227-4068

Philippines - Manila Tel: 63-2-634-9065 Fax: 63-2-634-9069

Singapore Tel: 65-6334-8870 Fax: 65-6334-8850

Taiwan - Hsin Chu Tel: 886-3-5778-366 Fax: 886-3-5770-955

Taiwan - Kaohsiung Tel: 886-7-213-7830 Taiwan - Taipei

Tel: 886-2-2508-8600 Fax: 886-2-2508-0102

Thailand - Bangkok Tel: 66-2-694-1351 Fax: 66-2-694-1350

#### EUROPE

Austria - Wels Tel: 43-7242-2244-39 Fax: 43-7242-2244-393

Denmark - Copenhagen Tel: 45-4450-2828 Fax: 45-4485-2829

Finland - Espoo Tel: 358-9-4520-820

France - Paris Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

France - Saint Cloud Tel: 33-1-30-60-70-00

**Germany - Garching** Tel: 49-8931-9700 **Germany - Haan** Tel: 49-2129-3766400

Germany - Heilbronn Tel: 49-7131-67-3636

Germany - Karlsruhe Tel: 49-721-625370

**Germany - Munich** Tel: 49-89-627-144-0 Fax: 49-89-627-144-44

**Germany - Rosenheim** Tel: 49-8031-354-560

Israel - Ra'anana Tel: 972-9-744-7705

Italy - Milan Tel: 39-0331-742611 Fax: 39-0331-466781

Italy - Padova Tel: 39-049-7625286

**Netherlands - Drunen** Tel: 31-416-690399 Fax: 31-416-690340

Norway - Trondheim Tel: 47-7289-7561

Poland - Warsaw Tel: 48-22-3325737

Romania - Bucharest Tel: 40-21-407-87-50

**Spain - Madrid** Tel: 34-91-708-08-90 Fax: 34-91-708-08-91

Sweden - Gothenberg Tel: 46-31-704-60-40

Sweden - Stockholm Tel: 46-8-5090-4654

**UK - Wokingham** Tel: 44-118-921-5800 Fax: 44-118-921-5820